AUTOMOTIVE

ROHS

HALOGEN

FREE GREEN

(5-2008)



Vishay Semiconductors

Ambient Light Sensor in 0805 Package



DESCRIPTION

TEMT6200FX01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 0805 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 550 nm.

FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- · High photo sensitivity
- · Adapted to human eye responsivity
- Supression filter for near infrared radiation
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



- Automotive sensors
- Ambient light sensor for display backlight dimming in:
 - Mobile phones
 - Notebook computers
 - PDAs
 - Cameras
- Dashboards

PRODUCT SUMMARY					
COMPONENT	I _{PCE} (μA) φ (deg)		λ _{0.5} (nm)		
TEMT6200FX01	23	± 60	450 to 610		

Note

Test condition see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	IG CODE PACKAGING REMARKS				
TEMT6200FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel. Label with I _{PCE} group on each reel. Specifications of group A/B/C see table "Type Dedicated Characteristics"	0805		

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Collector emitter voltage		V_{CEO}	6	V		
Emitter collector voltage		V_{ECO}	1.5	V		
Collector current		I _C	20	mA		
Power dissipation		P_V	100	mW		
Junction temperature		Tj	100	°C		
Operating temperature range		T _{amb}	-40 to +100	°C		
Storage temperature range		T _{stg}	-40 to +100	°C		
Soldering temperature	Acc. reflow profile fig. 9	T _{sd}	260	°C		
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	R _{thJA}	450	K/W		



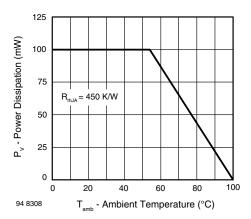


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	I _C = 0.1 mA	V_{CEO}	6			V
Collector dark current	V _{CE} = 5 V, E = 0 lx	I _{CEO}		3	50	nA
Collector emitter capacitance	$V_{CE} = 0 \text{ V, } f = 1 \text{ MHz, } E = 0 \text{ Ix}$	C _{CEO}		16		pF
Pleater and	$E_V = 20 Ix$, CIE illuminant A, $V_{CE} = 5 V$	I _{PCE}		4.6		μA
Photo current	$E_V = 100 \text{ lx}$, CIE illuminant A, $V_{CE} = 5 \text{ V}$	I _{PCE}	7.5	23	39	μΑ
Taxaaaa Maraa Maraa ah	CIE illuminant A	TK _{IPCE}		1.18		%/K
Temperature coefficient of I _{PCE}	LED, white	TK _{IPCE}		0.9		%/K
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λ_{p}		550		nm
Range of spectral bandwidth		λ _{0.5}		450 to 610		nm
Collector emitter saturation voltage	E _V = 20 lx, 0.45 μA	V _{CEsat}		0.1		V

TYPE DEDICATED CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	BINNED GROUP	SYMBOL	MIN.	MAX.	UNIT
Photo current	$E_V = 100 \text{ lx},$ CIE illuminant A, V_{CE} tz51 = 5 V	Α	I _{PCE}	7.5	15	μΑ
		В	I _{PCE}	12	24	μΑ
		С	I _{PCE}	19.5	39	μΑ

Note

Each 3000 piece packing unit will contain a single group. The label on the bag will indicate which binned group is in the bag. A specific group
cannot be ordered. Production shipments containing multiple bags will likely include multiple groups. Please design accordingly.

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

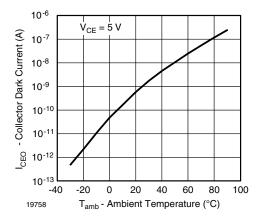


Fig. 2 - Collector Dark Current vs. Ambient Temperature

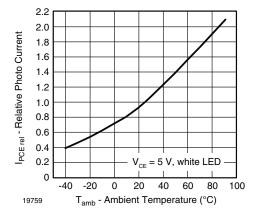


Fig. 3 - Relative Photo Current vs. Ambient Temperature

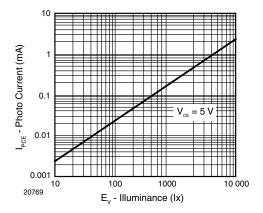


Fig. 4 - Photo Current vs. Illuminance

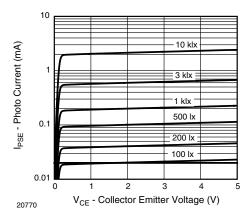


Fig. 5 - Photo Current vs. Collector Emitter Voltage

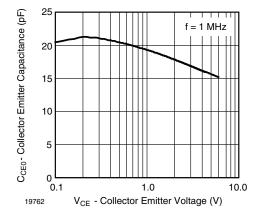


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

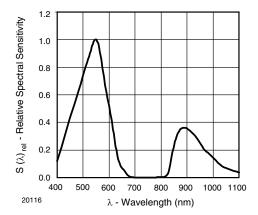


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

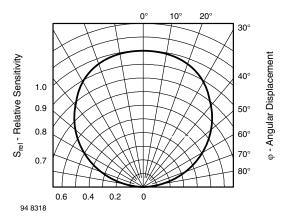


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE

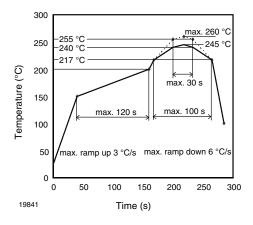


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

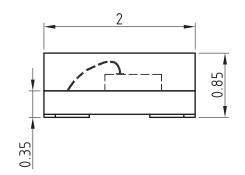
Floor life: 168 h

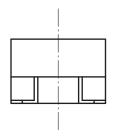
Conditions: T_{amb} < 30 °C, RH < 60 %

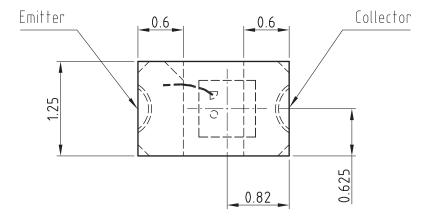
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

PACKAGE DIMENSIONS in millimeters

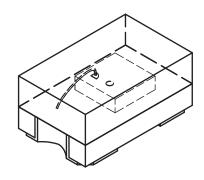




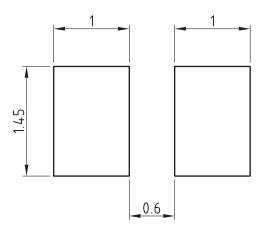




Not indicated tolerances ±0.1



Recommended solder pad Footprint

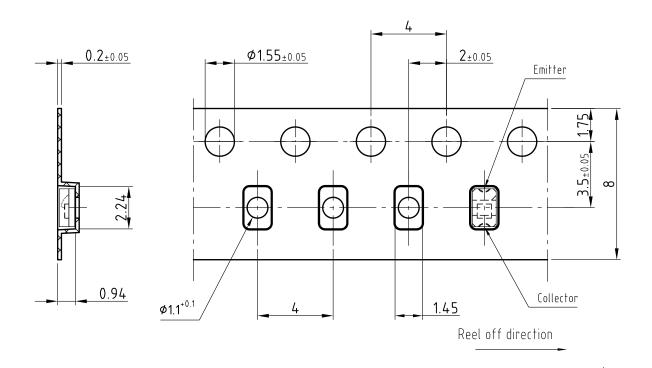


Drawing-No.: 6.541-5063.01-4

Issue: 3; 23.02.07

19757

BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5310.01-4

Issue: 2; 14.08.07

20690

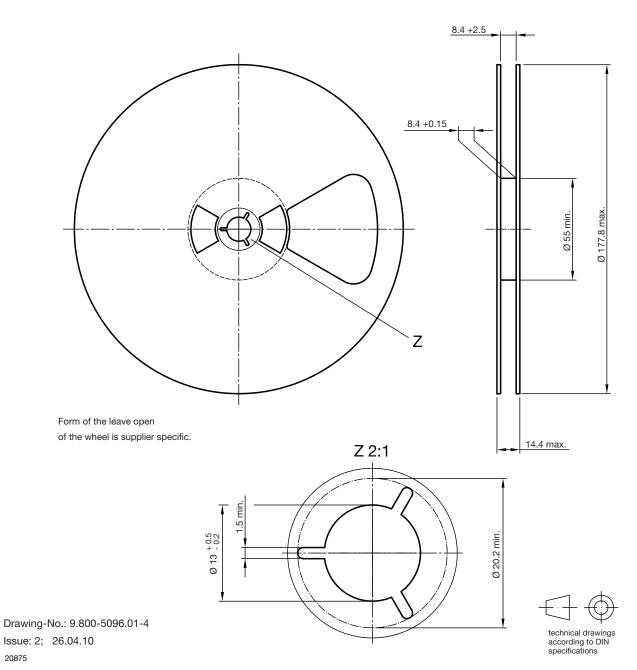
Not indicated tolerances ±0.1

Quantity per reel: 3000 pcs

technical drawings according to DIN specifications

REEL DIMENSIONS in millimeters

20875





Legal Disclaimer Notice

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